

Electronic Patent Application Fee Transmittal

Application Number:	10517445			
Filing Date:	09-Dec-2004			
Title of Invention:	Circuit formation substrate manufacturing method and circuit formation substrate material			
First Named Inventor/Applicant Name:	Toshihiro Nishii			
Filer:	Walter Carl Pledger/Linda Deutscher			
Attorney Docket Number:	2004-1930A			
Filed as Large Entity				
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	540	540
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				540